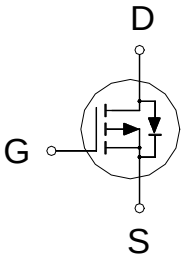
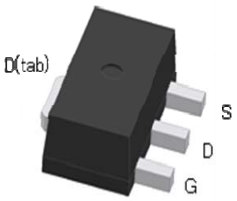
P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	-60V
$R_{DSON\ (MAX.)}$	150mΩ
I_D	-2.4A





Pb-Free Lead Plating & Halogen Free

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_A = 25 °C	I_D	-2.4	A
	T_A = 70 °C		-1.5	
Pulsed Drain Current[1]		I_{DM}	-9.6	
Power Dissipation	T_A = 25 °C	P_D	1.47	W
	T_A = 70 °C		0.94	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		18	°C / W
Junction-to-Ambient[3]	$R_{\theta JA}$		85	

[1]Pulse width limited by maximum junction temperature.

[2]Duty cycle ≤ 1%

[3]85°C / W when mounted on a 1 in^2 pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

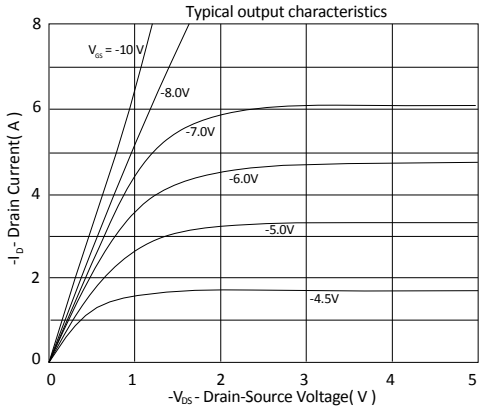
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = -250μA	-60			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250μA	-1	-1.7	-3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -48V, V_{GS} = 0V			-1	μA
		V_{DS} = -40V, V_{GS} = 0V, T_J = 125 °C			-25	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = -5V, V_{GS} = -10V	-2.4			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = -10V, I_D = -2.4A		125	150	mΩ
		V_{GS} = -4.5V, I_D = -2.0A		160	200	
Forward Transconductance[1]	g_{fs}	V_{DS} = -5V, I_D = -2A		3		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = -30V, f = 1MHz		1032		pF
Output Capacitance	C_{oss}			66		
Reverse Transfer Capacitance	C_{rss}			48		
Total Gate Charge[1,2]	Q_g	V_{DS} = -10V, V_{GS} = -10V, I_D = -2A		12.3		nC
Gate-Source Charge[1,2]	Q_{gs}			1.6		
Gate-Drain Charge[1,2]	Q_{gd}			2.4		
Turn-On Delay Time[1,2]	$t_{d(on)}$	V_{DS} = -10V, I_D = -1A, V_{GS} = -10V, R_{GS} = 6Ω		12		nS
Rise Time[1,2]	t_r			20		
Turn-Off Delay Time[1,2]	$t_{d(off)}$			20		
Fall Time[1,2]	t_f			25		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)						
Continuous Current	I_S				-2.4	A
Pulsed Current[3]	I_{SM}				-9.6	
Forward Voltage[1]	V_{SD}	I_F = I_S, V_{GS} = 0V			1.2	V

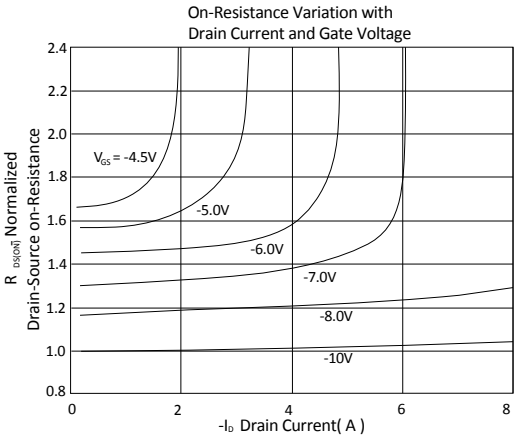
[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

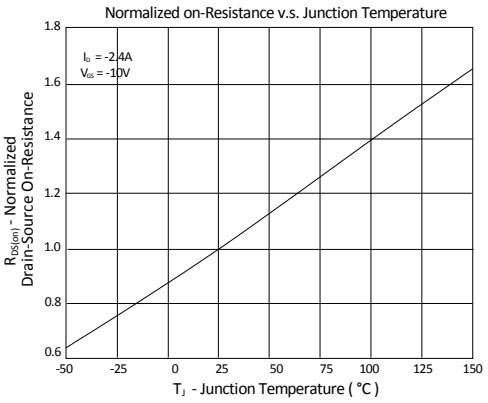
[2]Independent of operating temperature.

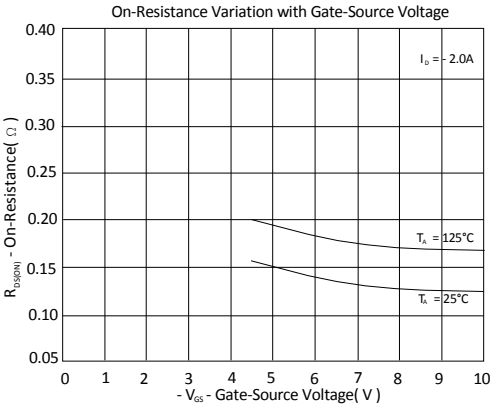
[3]Pulse width limited by maximum junction temperature.

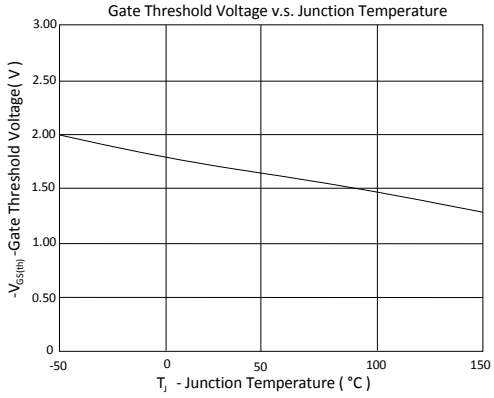
TYPICAL CHARACTERISTICS

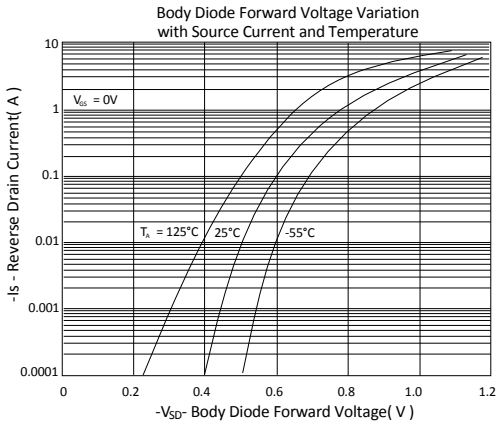




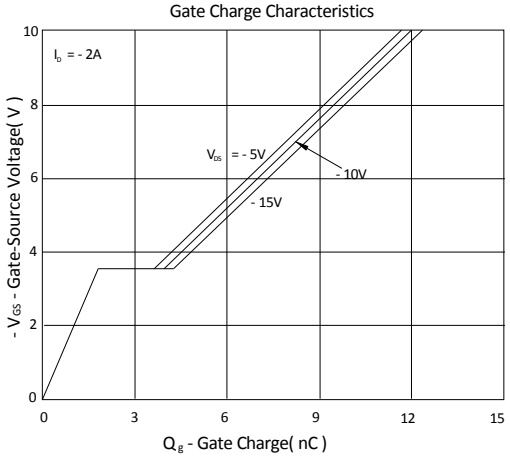




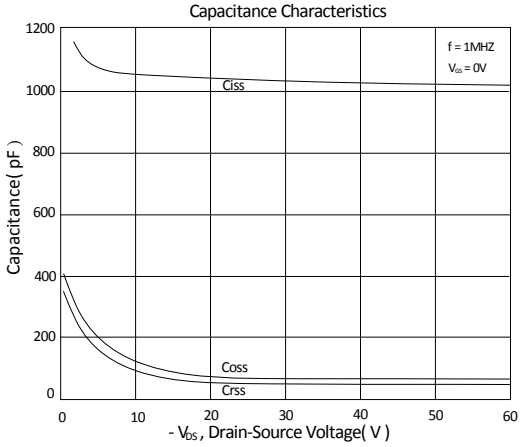




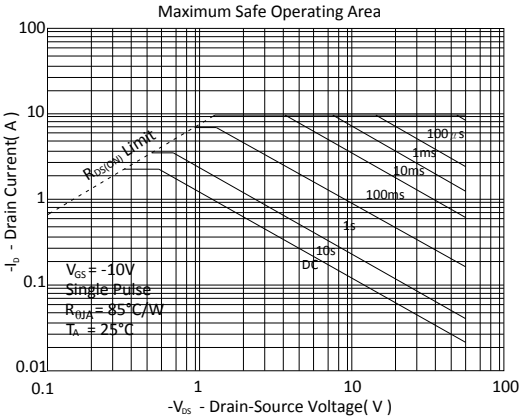
Gate Charge Characteristics



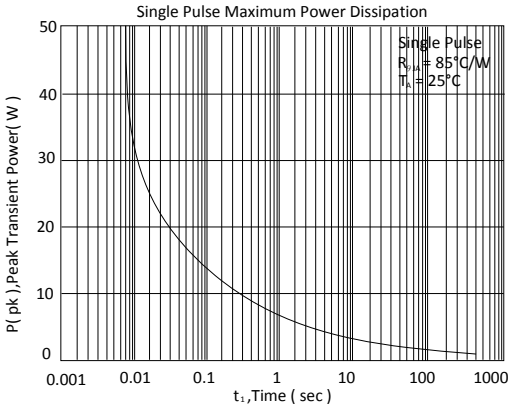
Capacitance Characteristics



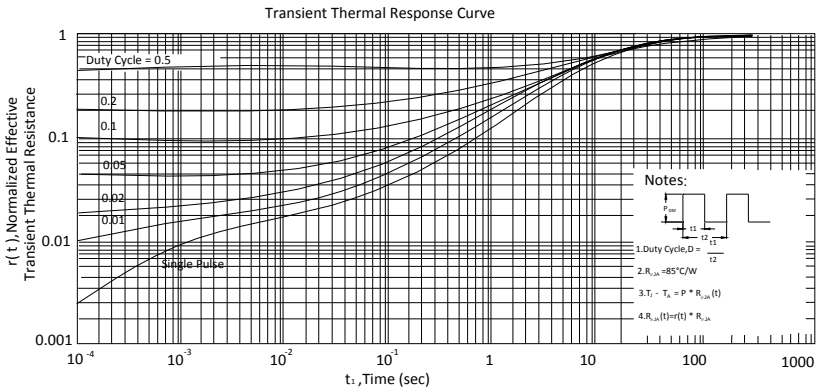
Maximum Safe Operating Area



Single Pulse Maximum Power Dissipation

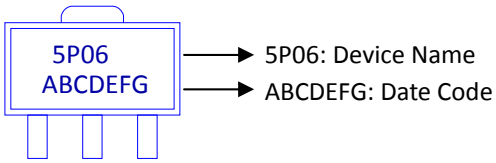


Transient Thermal Response Curve

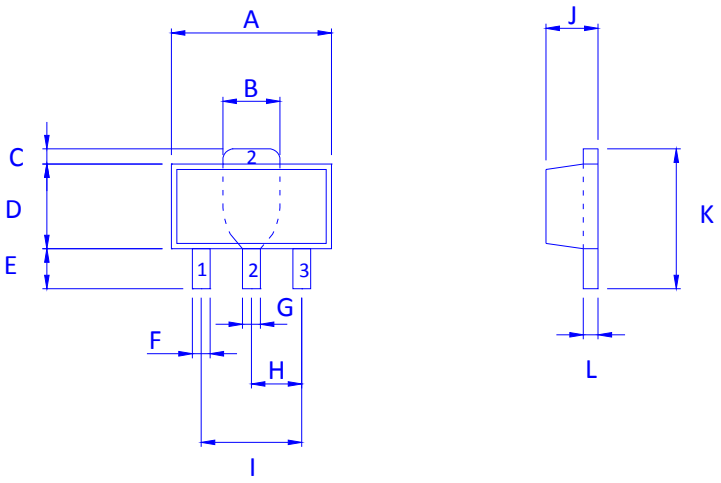


Ordering & Marking Information:

Device Name: LB5P06J for SOT-89



Outline Drawing



Dimension in mm

Dimension	A	B	C	D	E	F	G	H	I	J	K	L
in.	4.30	1.60	0.40	2.40	0.80	0.40	0.40	1.40	2.80	1.30	3.80	0.30
Typ.												
Max.	4.70	1.80	0.60	2.60	1.40	0.50	0.60	1.60	3.20	1.70	4.60	0.50

Footprint